PIC32MZ EF FAMILY

PIC32MZ Embedded Connectivity with Floating Point Unit (EF) Family Silicon Errata and Data Sheet Clarification

The PIC32MZ Embedded Connectivity with Floating Point Unit (EF) family of devices that you have received conform functionally to the current Device Data Sheet (DS60001320**D**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the PIC32MZ Embedded Connectivity with Floating Point Unit (EF) family silicon.

> **Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (**A3**).

Data Sheet clarifications and corrections (if applicable) start on page 9, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® X IDE and Microchip's programmers, debuggers and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB X IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB X IDE project.
3. Configure the MPLAB X IDE project for the appropriate device and hardware debugger.
4. Select *Window > Dashboard*, and then click the **Refresh Debug Tool Status** icon (🔃).
5. The part number and the Device and Revision ID values appear in the **Output** window.

> **Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The Device and Revision ID values for the various PIC32MZ EF Family silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID[1]	Revision ID for Silicon Revision[1]	
		A1	A3
PIC32MZ0512EFE064	0x7201053		
PIC32MZ0512EFF064	0x7206053		
PIC32MZ0512EFK064	0x722E053		
PIC32MZ1024EFE064	0x7202053		
PIC32MZ1024EFF064	0x7207053		
PIC32MZ1024EFK064	0x722F053		
PIC32MZ1024EFG064	0x7203053	0x1	0x3
PIC32MZ1024EFH064	0x7208053		
PIC32MZ1024EFM064	0x7230053		
PIC32MZ2048EFG064	0x7204053		
PIC32MZ2048EFH064	0x7209053		
PIC32MZ2048EFM064	0x7231053		

Note 1: Refer to the **"Memory Organization"** and **"Special Features"** chapters in the current Device Data Sheet (DS60001320**D**) for detailed information on Device and Revision IDs for your specific device.

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TABLE 1: SILICON DEVREV VALUES (CONTINUED)

Part Number	Device ID[1]	Revision ID for Silicon Revision[1]	
		A1	A3
PIC32MZ0512EFE100	0x720B053		
PIC32MZ0512EFF100	0x7210053		
PIC32MZ0512EFK100	0x7238053		
PIC32MZ1024EFE100	0x720C053		
PIC32MZ1024EFF100	0x7211053		
PIC32MZ1024EFK100	0x7239053	0x1	0x3
PIC32MZ1024EFG100	0x720D053		
PIC32MZ1024EFH100	0x7212053		
PIC32MZ1024EFM100	0x723A053		
PIC32MZ2048EFG100	0x720E053		
PIC32MZ2048EFH100	0x7213053		
PIC32MZ2048EFM100	0x723B053		
PIC32MZ0512EFE124	0x7215053		
PIC32MZ0512EFF124	0x721A053		
PIC32MZ0512EFK124	0x7242053		
PIC32MZ1024EFE124	0x7216053		
PIC32MZ1024EFF124	0x721B053		
PIC32MZ1024EFK124	0x7243053	0x1	0x3
PIC32MZ1024EFG124	0x7217053		
PIC32MZ1024EFH124	0x721C053		
PIC32MZ1024EFM124	0x7244053		
PIC32MZ2048EFG124	0x7218053		
PIC32MZ2048EFH124	0x721D053		
PIC32MZ2048EFM124	0x7245053		
PIC32MZ0512EFE144	0x721F053		
PIC32MZ0512EFF144	0x7224053		
PIC32MZ0512EFK144	0x724C053		
PIC32MZ1024EFE144	0x7220053		
PIC32MZ1024EFF144	0x7225053		
PIC32MZ1024EFK144	0x724D053	0x1	0x3
PIC32MZ1024EFG144	0x7221053		
PIC32MZ1024EFH144	0x7226053		
PIC32MZ1024EFM144	0x724E053		
PIC32MZ2048EFG144	0x7222053		
PIC32MZ2048EFH144	0x7227053		
PIC32MZ2048EFM144	0x724F053		

Note 1: Refer to the **"Memory Organization"** and **"Special Features"** chapters in the current Device Data Sheet (DS60001320**D**) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: **SILICON ISSUE SUMMARY**

Module	Feature	Issue	Issue Summary	Affected Revisions[1]	
				A1	A3
Oscillator	Reference Clock	1.	The Reference Clock cannot divide input frequencies greater than 100 MHz.	X	X
Oscillator	Primary Oscillator Crystal	2.	**Revision A1 Silicon:** A crystal oscillator cannot be used as an input to the Primary Oscillator (OSC1/OSC2 pins). **Revision A3 Silicon:** The Primary Oscillator has been tested in a normal power-up sequence and supports specific crystal operation.	X	X
Oscillator	FRC Tuning	3.	The OSCTUN register only increases the frequency of the FRC.	X	
Secondary Oscillator	Crystal Use	4.	The Secondary Oscillator (SOSC) does not support crystal operation.	X	X
Power-Saving	PMD bits	5.	Turning off REFCLK through the PMD bits causes unpredictable device behavior.	X	X
I^{2}C	—	6.	The I^{2}C module does not function reliably under certain conditions.	X	X
UART	Auto-baud	7.	The Auto-baud feature does not function to set the baud rate.	X	X
UART	Synchronization	8.	On a RX FIFO overflow, shift registers stop receiving data, which causes the UART to lose synchronization.	X	X
USB	Suspend Mode	9.	The USB module will not function if the device enters Sleep mode and the USB PHY is turned off by setting the USBSSEN bit in the CFGCON register to '1'.	X	X
Power-Saving Modes	Sleep Mode	10.	The device may not exit Sleep mode.	X	X
ADC	Digital Filters	11.	Using multiple digital filters may result in data not being captured accurately.	X	X
ADC	Level Trigger	12.	The ADC level trigger will not perform burst conversions in Debug mode.	X	X
ADC	DNL	13.	In Differential mode, DNL for code 3072 is out of specification.	X	X
ADC	Low-voltage Operation	14.	When the operating voltage (VDD/AVDD) is below 2.5V (i.e., charge pumps are ON), only one ADC core can be used.	X	X
ADC	Turbo Mode	15.	Turbo mode is not functional.	X	X
USB	Resume	16.	The USB module does not support remote wake-up.	X	X
Oscillator	External Clock Mode	17.	The EC mode timing specifications for the Primary Oscillator (POSC) are not met.	X	
Temperature Sensor	—	18.	The Temperature Sensor does not function.	X	X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

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Silicon Errata Issues

> **Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A3**).

1. Module: Oscillator

The Reference Module cannot divide input frequencies greater than 100 MHz. Therefore, SYSCLK cannot be divided if the SYSCLK operates at frequencies greater than 100 MHz.

Work around

Instead of using SYSCLK, use PBCLK1 as the input, which is limited to 100 MHz and is synchronized to SYSCLK.

Alternatively, do not divide the SYSCLK and allow the destination peripheral (i.e., SQI, SPI) to divide it as needed. To do this, set the RODIV<14:0> bits and the ROTRIM<8:0> bits to '0'.

Affected Silicon Revisions

A1	A3						
X	X						

2. Module: Oscillator

Revision A1 Silicon: A crystal oscillator cannot be used as an input to the Primary Oscillator (POSC) pins OSC1 and OSC2.

Revision A1 Silicon Work around

Use an external clock or the Internal FRC Oscillator.

Affected Silicon Revisions

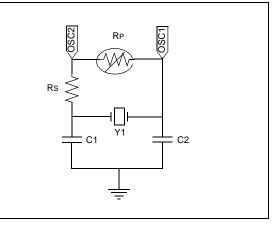| A1	A3						
X							

Revision A3 Silicon: The POSC has been tested in a normal power-up sequence and supports specific crystal operation.

Revision A3 Silicon Work around 1

The Primary Oscillator (POSC) has been characterized to operate at 8 MHz, 12 MHz, and 24 MHz when the circuit in Figure 1 is implemented, and the operating conditions listed in Table 3 are met.

FIGURE 1: POSC CRYSTAL CIRCUIT

TABLE 3: CRYSTAL SPECIFICATIONS

Crystal Frequency (see Note 1)	Series Resistor (Rs)	POSC Gain Setting POSCGAIN<1:0> (DEVCFG0<20:19>)	POSC Boost Setting POSCBOOST (DEVCFG0<21>)
8 MHz	2 kΩ	'b00 (GAIN_0)	'b1 (ON)
12 MHz	1 kΩ	'b00 (GAIN_0)	'b1 (ON)
24 MHz	0 kΩ	'b00 (GAIN_0))	'b1 (ON)

> **Note 1:** Using any other crystal frequency will require special component selection and characterization.
>
> **2:** A parallel resistor (RP) should not be used to increase the gain of the POSC.

Revision A3 Silicon Work around 2

Alternatively, use an external clock or the Internal FRC oscillator.

Affected Silicon Revisions

A1	A3						
	X						

3. Module: Oscillator

The OSCTUN register only increases the frequency of the FRC, which results in the TUN<5:0> bits (OSCTUN<5:0>) functioning as follows:

TUN<5:0>: FRC Oscillator Tuning bits

`111111` = Center frequency +4%

`111110` =

•
•
•

`000001` =

`000000` = Center frequency; Oscillator runs at nominal frequency (8 MHz)

Work around

None.

Affected Silicon Revisions

A1	A3						
X							

4. Module: Secondary Oscillator

A crystal oscillator cannot be used as the input to the Secondary Oscillator (SOSC) pins SOSCI and SOSCO.

Silicon Work around

Use an external clock source (32,768 Hz) applied to the SOSCO pin with the FSOSCEN bit (DEVCFG1<6>) set to '0' (i.e., the SOSC is disabled through the Configuration Word) for a real-time clock base; otherwise, use the internal LPRC for non-precision requirements.

Affected Silicon Revisions

A1	A3						
X	X						

5. Module: Power-Saving

Turning off the REFCLK modules through the PMD bits causes unpredictable behavior.

Work around

None. Do not disable the REFCLK modules through the PMD bits.

Affected Silicon Revisions

A1	A3						
X	X						

6. Module: I^{2}C

Indeterminate I^{2}C module behavior may result when data rates > 100 kHz and/or continuous sequential data transfers > 500 bytes are used.

The potential false intermittent error signals can result in one of the following error conditions, which are listed in order of decreasing frequency:

• **False Error Condition 1:**
  False Master Bus Collision Detect (Master-mode only) – The error is indicated through the BCL bit (I2CxSTAT<10>).

• **False Error Condition 2:**
  Receive Overflow (Master or Slave modes) – The error is indicated through the I2COV bit (I2CxSTAT<20>).

• **False Error Condition 3:**
  Suspended I^{2}C Module Operations (Master or Slave modes) – I^{2}C transactions in progress are inadvertently suspended without error indications.

> **Note:** All three false error conditions are recoverable in software.

Revision A1 Silicon Work around 1

False Error Condition 1:

Clear the Master Bus Collision Detect (BCL bit (I2CxSTAT<10>), after the bus returns to an Idle state. The software can monitor the S bit (I2CxSTAT<3>) and the P bit (I2CxSTAT<4>) to wait for an Idle bus. When the software services the bus collision Interrupt Service Routine and the I^{2}C bus is free, the software can resume communication by asserting a new Start condition.

False Error Condition 2:

Clear the Receive Overflow Status flag I2COV bit (I2CxSTAT<20>), and then resume normal operation.

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False Error Condition 3:

First, initialize a Timer to slightly greater than the worst case I^2C transaction cycle, (i.e., from Start-to-Stop, including the sum of all other application PC flow latencies, calls, interrupts, etc.). Exact timing is not required, rather just long enough so that a normal transaction is not interrupted. Prior to the beginning of each transaction, start the timer. Be sure to stop and reset the timer after completion of each successful I^2C transaction.

Then, during the Timer interrupt (meaning the I^2C transaction has timed out), disable the I^2C module by setting the ON bit (I2CxCON<15>) = `0`. After disabling the module, wait 4 instruction cycles, after which time the I2CxSTAT register will automatically be cleared. Then, re-enable the I^2C module by setting the ON bit = `1` and resume normal operation.

Revision A1 Silicon Work around 2

Instead of using the hardware I^2C module, use a software "bit-bang" implementation.

Revision A3 Silicon Work around

The work arounds described for revision A1 silicon will also work for silicon revision A3, with the exception of I2C3, as I2C3 must use a software "bit-bang" implementation.

Affected Silicon Revisions

A1	A3						
X	X						

7. Module: UART

The UART automatic baud rate feature is intended to set the baud rate during run-time based on external data input. However, this feature does not function.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

8. Module: UART

During a RX FIFO overflow condition, the shift register stops receiving data. This causes the UART to lose synchronization with the serial data stream. The only way to recover from this is to turn the UART OFF and ON until it synchronizes. This could require several OFF/ON sequences.

Work arounds

Work around 1:

Avoid the RX overrun condition by ensuring that the UARTx module has a high enough interrupt priority such that other peripheral interrupt processing latencies do not exceed the time to overrun the UART RX buffer based on the application baud rate. Alternately or in addition to, set the URXISEL bits in the UxSTA register to generate an earlier RX interrupt based on RX FIFO fill status to buy more time for interrupt latency processing requirements.

Work around 2:

If avoiding RX FIFO overruns is not possible, implement an ACK/NAK software handshake protocol to repeat lost packet transfers after restoring the UART synchronization.

Affected Silicon Revisions

A1	A3						
X	X						

9. Module: USB

The USB module will not function if the device enters Sleep mode and the USB PHY is turned off by setting the USBSSEN bit in the CFGCON register to '`1`'.

Work around

Keep the USB PHY operational in Sleep mode by setting the USBSSEN bit to '`0`'.

Affected Silicon Revisions

A1	A3						
X	X						

10. Module: Power-Saving Modes

The device may not exit Sleep mode when Flash is powered down through the FSLEEP bit in the DEVCFG0/ADEVCFG0 Configuration register.

Work around

Enable Flash in Sleep mode by clearing the Flash Sleep Mode Configuration bit, FSLEEP, in the DEVCFG0/ADEVCFG0 Configuration register.

Affected Silicon Revisions

A1	A3						
X	X						

11. Module: ADC

When using multiple digital filters, the filters may not capture data correctly when the assigned data sources are ready at the same time.

Work around

Only one digital filter may be used at a time.

Affected Silicon Revisions

A1	A3						
X	X						

12. Module: ADC

The ADC level trigger will not perform burst conversions in Debug mode.

Work around

Do not use Debug mode with the ADC level trigger.

Affected Silicon Revisions

A1	A3						
X	X						

13. Module: ADC

In Differential mode, code 3072 has a DNL of +3.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

14. Module: ADC

When the operating voltage (V_{DD}/AV_{DD}) is below 2.5V (i.e., charge pumps are ON), only one ADC core can be used.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

15. Module: ADC

Turbo mode is not functional when two channels are linked for the purpose of increasing throughput.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

16. Module: USB

The USB module does not support remote wake-up through the USBRIE bit (USBCRCON<1>).

Work around

None.

USB descriptors must inform the host that the device does not support remote wake-up.

Affected Silicon Revisions

A1	A3						
X	X						

17. Module: Oscillator

The Primary Oscillator in EC mode only functions up to 24 MHz

Work around

None.

Affected Silicon Revisions

A1	A3						
X							

18. Module: Temperature Sensor

The Temperature Sensor does not function.

Work around

None.

Affected Silicon Revisions

A1	A3						
X	X						

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS60001320**D**):

> **Note:** Corrections in tables are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

1. Module: Resets

Deleted the General NMI (GNMI) bit from Register 6-3. This bit is not available for either triggering an NMI event or for reflecting the status of the NMIKEY bit (INTCON<31:24>), which is also removed.

REGISTER 6-3: RNMICON: NON-MASKABLE INTERRUPT (NMI) CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	—	—	—	—	—	—	DMTO	WDTO
23:16	R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	SWNMI	—	—	—	—	—	CF	WDTS
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	NMICNT<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	NMICNT<7:0>							

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31-26 **Unimplemented:** Read as '0'

bit 25 **DMTO:** Deadman Timer Time-out Flag bit
1 = DMT time-out has occurred and caused a NMI
0 = DMT time-out has not occurred
Setting this bit will cause a DMT NMI event, and NMICNT will begin counting.

bit 24 **WDTO:** Watchdog Timer Time-Out Flag bit
1 = WDT time-out has occurred and caused a NMI
0 = WDT time-out has not occurred
Setting this bit will cause a WDT NMI event, and MNICNT will begin counting.

bit 23 **SWNMI:** Software NMI Trigger.
1 = An NMI will be generated
0 = An NMI will not be generated

bit 22-18 **Unimplemented:** Read as '0'

> **Note 1:** When a Watchdog Timer NMI event (when not in Sleep mode) or a Deadman Timer NMI event is triggered, the NMICNT bit will start decrementing. When the NMICNT bit reaches zero, the device is Reset. This NMI reset counter is only applicable to these two specific NMI events.

> **Note:** The system unlock sequence must be performed before the SWRST bit can be written. Refer to **Section 42. "Oscillators with Enhanced PLL"** in the *"PIC32 Family Reference Manual"* for details.

REGISTER 6-3: **RNMICON: NON-MASKABLE INTERRUPT (NMI) CONTROL REGISTER (CONTINUED) (CONTINUED) (CONTINUED)**

bit 17 **CF:** Clock Fail Detect bit
1 = FSCM has detected clock failure and caused an NMI
0 = FSCM has not detected clock failure

Setting this bit will cause a a CF NMI event, but will not cause a clock switch to the BFRC.

bit 16 **WDTS:** Watchdog Timer Time-out in Sleep Mode Flag bit
1 = WDT time-out has occurred during Sleep mode and caused a wake-up from sleep
0 = WDT time-out has not occurred during Sleep mode

Setting this bit will cause a WDT NMI.

bit 15-0 **NMICNT<15:0>:** NMI Reset Counter Value bits
1111111111111111-0000000000000001 = Number of SYSCLK cycles before a device Reset occurs[1]
0000000000000000 = No delay between NMI assertion and device Reset event

Note 1: When a Watchdog Timer NMI event (when not in Sleep mode) or a Deadman Timer NMI event is triggered, the NMICNT bit will start decrementing. When the NMICNT bit reaches zero, the device is Reset. This NMI reset counter is only applicable to these two specific NMI events.

Note: The system unlock sequence must be performed before the SWRST bit can be written. Refer to **Section 42. "Oscillators with Enhanced PLL"** in the *"PIC32 Family Reference Manual"* for details.

2. Module: Interrupt Controller

Deleted the NMIKEY<7:0> bit from Register 7-1. The ability to trigger an NMI event through the NMIKEY field is not available, and the corresponding status bit GNMI (RNMICON<19>) is also not available.

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	—	—	MVEC	—	TPC<2:0>		
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31-13 **Unimplemented:** Read as '0'

bit 12 **MVEC:** Multi Vector Configuration bit

1 = Interrupt controller configured for multi vectored mode
0 = Interrupt controller configured for single vectored mode

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits

111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
001 = Interrupts of group priority 1 start the Interrupt Proximity timer
000 = Disables Interrupt Proximity timer

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **INT4EP:** External Interrupt 4 Edge Polarity Control bit

1 = Rising edge
0 = Falling edge

bit 3 **INT3EP:** External Interrupt 3 Edge Polarity Control bit

1 = Rising edge
0 = Falling edge

bit 2 **INT2EP:** External Interrupt 2 Edge Polarity Control bit

1 = Rising edge
0 = Falling edge

bit 1 **INT1EP:** External Interrupt 1 Edge Polarity Control bit

1 = Rising edge
0 = Falling edge

bit 0 **INT0EP:** External Interrupt 0 Edge Polarity Control bit

1 = Rising edge
0 = Falling edge

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3. Module: External Clock Timing Requirements

The Fosc signal maximum frequency in parameter OS10 was incorrectly stated in the current data sheet. The following table shows the correct maximum value.

TABLE 37-17: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C $\leq$ T$_A$ $\leq$ +85°C for Industrial -40°C $\leq$ T$_A$ $\leq$ +125°C for Extended				
Param. No.	Symbol	Characteristics	Minimum	Typical[1]	Maximum	Units	Conditions
OS10	F$_{OSC}$	External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC	—	**50**	MHz	EC (Note 2,3)

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are characterized but are not tested.

     2: This parameter is characterized, but not tested in manufacturing.

     3: See parameter OS50 for PLL input frequency limitations.

APPENDIX A: REVISION HISTORY

Rev A Document (7/2015)

Initial release of this document issued for revision A1 silicon, which includes silicon issues 1. Module: (Oscillator), 2. Module: (Oscillator), 3. Module: (Oscillator), 4. Module: (Secondary Oscillator), 5. Module: (Power-Saving), 6. Module: (I^2C), 7. Module: (UART), 8. Module: (UART), 9. Module: (USB), and Power-Saving Modes.

Rev B Document (4/2016)

Added silicon issues 11. Module: (ADC) and 12. Module: (ADC).

Updated silicon issues 2. Module: (Oscillator) and 10. Module: (Power-Saving Modes).

Rev C Document (7/2016)

Updated to include silicon revision A3.

Updated silicon issues 2. Module: (Oscillator), 6. Module: (I^2C), and 11. Module: (ADC).

Added silicon issues 13. Module: (ADC), 14. Module: (ADC), 15. Module: (ADC), and 16. Module: (USB).

Added data sheet clarifications 1. Module: (Resets) and 2. Module: (Interrupt Controller).

Rev D Document (9/2016)

Updated Figure 1 and Table 3 in silicon issue 2. Module: (Oscillator).

Added silicon issues 17. Module: (Oscillator) and 18. Module: (Temperature Sensor).

Added data sheet clarification 3. Module: (External Clock Timing Requirements).

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.

- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.

- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.

- Microchip is willing to work with the customer who is concerned about the integrity of their code.

- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

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